TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC7WH123FU, TC7WH123FK

Monostable Multivibrator

The TC7WH123 is high speed CMOS MONOSTABLE MULTIVIBRATOR fabricated with silicon gate C²MOS technology.

There are two trigger inputs, \overline{A} input (Negative edge), and B input (Positive edge). These inputs are valid for a slow rise/fall time signal (tr = tf = 1 s) as they are schmitt trigger inputs. This device may also be triggered by using $\overline{\rm CLR}$ input (Positive edge).

After triggering, the output stays in a MONOSTABLE state for a time period determined by the external resistor and capacitor (Rx, Cx). A low level at the $\overline{\rm CLR}$ input breaks this state.

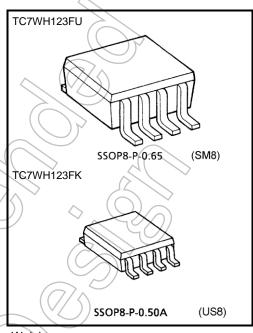
Limits for Cx and Rx are:

External capacitor, Cx: No limit

External resistor, Rx: VCC = 2.0 V more than $5 \text{ k}\Omega$

VCC ≥ 3.0 V more than 1 k Ω

An input protection circuit ensures that 0 to 7 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.



Weight

SSOP8-P-0.65

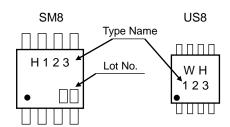
: 0.02 g (typ.)

SSOP8-P-0.50A : 0.01 g (typ.)

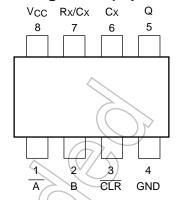
Features

- High speed: tpd = 8.1 ns (typ.) at VCC = 5 V
- Low power dissipation
- Standby state: ICC = 2 μA (max) at Ta = 25°C
- Active state : ICC = 650 μA (max) at VCC = 4.5 V
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- · Power down protection is equipped with all inputs.
- Balanced propagation delays: tpLH ≈ tpHL
- Wide operating voltage range: VCC (opr) = 2 to 5.5 V

Marking



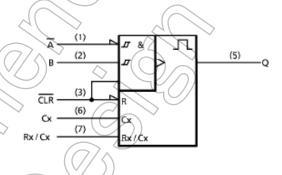
Pin Assignment (top view)



Truth Table

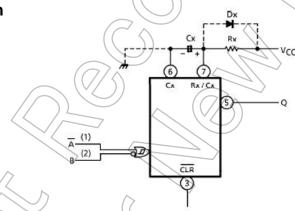
	Inputs		Outputs	Note
\overline{A}	В	CLR	Q	
\Box	Н	Н	Л	Output Enable
Х	L	Н	L	Inhibit
Н	Х	Н	L	Inhibit
L		Н	Л	Output Enable
L	Н		Л	Output Enable
Х	Х	L	L	Reset

IEC Logic Symbol



X: Don't care

Block Diagram



Note: Cx, Rx, Dx are external capacitor, resistor, and diode, respectively.

Note: External clamping diode, Dx;

The external capacitor is charged to VCC level in the wait state, i.e. when no trigger is applied.

If the supply voltage is turned off, Cx is discharges mainly through the internal (parasitic) diode. If Cx is sufficiently large and Vcc drops rapidly, there will be some possibility of damaging the IC through in rush current or latch-up. If the capacitance of the supply voltage filter is large enough and Vcc drops slowly, the in rush current is automatically limited and damage to the IC is avoided.

The maximum value of forward current through the parasitic diode is ±20 mA.

In the case of a large Cx, the limit of fall time of the supply voltage is determined as follows:

$$t_f \ge (V_{CC} - 0.7) \cdot C_X / 20 \text{ mA}$$

(tf is the time between the supply voltage turn off and the supply voltage reaching 0.4 Vcc.)

In the even a system does not satisfy the above condition, an external clamping diode (Dx) is needed to protect the IC from rush current.

Functional Description

(1) Standby state

The external capacitor (Cx) is fully charged to VCC in the stand-by state. That means, before triggering, the QP and QN transistors which are connected to the Rx/Cx node are in the off state. Two comparators that relate to the timing of the output pulse, and two reference voltage supplies turn off. The total supply current is only leakage current.

(2) Trigger operation

Trigger operation is effective in any of the following three cases. First, the condition where the \overline{A} input is low, and the B input has a rising signal; second, where the B input is high, and the \overline{A} input has a falling signal; and third, where the \overline{A} input is low and the B input is high, and the \overline{CLR} input has a rising signal.

After a trigger becomes effective, comparators C1 and C2 start operating, and QN is turned on. The external capacitor discharges through QN. The voltage level at the RX/CX node drops. If the RX/CX voltage level falls to the internal reference voltage VrefL, the output of C1 becomes low. The flip-flop is then reset and QN turns off. At that moment C1 stops but C2 continues operating.

After QN turns off, the voltage at the Rx/Cx node starts rising at a rate determined by the time constant of external capacitor Cx and resistor Rx.

Upon triggering, output Q becomes high, following some delay time of the internal F/F and gates. It stays high even if the voltage of Rx/Cx changes from falling to rising. When Rx/Cx reaches the internal reference voltage VrefH, the output of C2 becomes low, the output Q goes low and C2 stops its operation. That means, after triggering, when the voltage level of the Rx/Cx node reaches VrefH, the IC returns to its MONOSTABLE state.

With large values of Cx and Rx, and ignoring the discharge time of the capacitor and internal delays of the IC, the width of the output pulse, tw OUT, is as follows:

 $twOUT = 1.0 \cdot CX \cdot RX$

(3) Retrigger operation

When a new trigger is applied to either input \overline{A} or B while in the MONOSTABLE state, it is effective only if the IC is charging Cx. The voltage level of the Rx/Cx node then falls to VrefL level again. Therefore the Q output stays high if the next trigger comes in before the time period set by Cx and Rx.

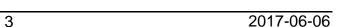
If the new trigger is very close to previous trigger, such as an occurrence during the discharge cycle, it will have no effect.

The minimum time for a trigger to be effective 2nd trigger, trr (min), depends on VCC and CX.

(4) Reset operation

In normal operation, the $\overline{\rm CLR}$ input is held high. If $\overline{\rm CLR}$ is low, a trigger has no effect because the Q output is held low and the trigger control F/F is reset. Also, QP turns on and CX is charged rapidly to VCC.

This means if $\overline{\rm CLR}$ is set low, the IC goes into a wait state.



Absolute Maximum Ratings ($T_a = 25$ °C) (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	⟨_V
DC output voltage	Vout	-0.5 to V _{CC} + 0.5	A
Input diode current	I _{IK}	-20	(mA
Output diode current	lok	±20 (Note 1)	mA
DC output current	lout	±25	mΑ
DC V _{CC} /ground current	Icc	±50	mA
Dower dissination	D-	300 (SM8)	> m\\\
Power dissipation	P _D	200 (US8)	mW
Storage temperature	T _{stg}	-65 to 150	°C ,
Lead temperature (10 s)	TL	260	°C {

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Vout<GND, VOUT>Vcc

Operating Ranges (Note)

	// < \		
Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2.0 to 5.5	V
Input voltage	VIN	0 to 5.5	V
Output voltage	Vout	0 to Vcc	V
Operating temperature	Topr	-40 to 85	°C
Input rise and fall time	dt/dV	0 to 100 (V _{CC} = 3.3 ± 0.3 V) 0 to 20 (V _{CC} = 5 ± 0.5 V)	ns/V
External capacitor	CX	No limitation (Note 1)	F
External resistor	RX	\geq 5 k (V _{CC} = 2.0 V) (Note 1) \geq 1 k (V _{CC} \geq 3.0 V) (Note 1)	Ω

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 1: The maximum allowable values of C_X and R_X are a function of leakage of capacitor C_X , the leakage of TC7WH123FU/FK, and leakage due to board layout and surface resistance. Susceptibility to externally induced noise signals may occur for $R_X > 1 \text{ M}\Omega$.

DC ELECTRICAL CHARACTERISTICS (Unless otherwise specified, Input t_{r} = t_{f} = 3 ns)

The control input Characteristic BOL Test control CV MIN. TYP. MAX. MIN.	CHARACTERISTIC		SYM-	TEST CONDITION		Vcc	1	「a = 25°0		Ta = -4	0∼85°C	UNIT
Input Voltage TH" Level VIH S.5.5 × 0.7 - VCC V	CHARAC	TERISTIC	BOL	TEST CONDITION		V _C C (V)	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT
Input Voltage						2.0	1.5	_	- (1.5		
Voltage "L" Level "H" Level "H" Level "H" Level "UN VOH "VIN VOH "UN VIN VIN VIN VIN VIN VIN VIN V		"H" Level	VIH						_/	Vcc		
Voltage "L" Level "H" Level VOH "H" Level VOH "H" Level VOH VIN VIN VIN VIN VIN VIN VIN VI	l '						×0.7			×0.7		v
The Level VOH VIN IOH = -50μA 3.0 2.9 3.0 - 2.9 - 4.5 4.4 4.5 - 4.4 - 4.5 - 4.5	Voltage					_		<u> </u>) —		ľ
Output Voltage		"L" Level	VIL				_			ľ _		
Output Voltage						_			\rightarrow		×0.3	
Output Voltage						$\overline{}$						
Output Voltage					$I_{OH} = -50\mu A$			\rightarrow	_		$\overline{\mathcal{L}}$	
Output Voltage Voltage IOH = -8mA 4.5 3.94 — 3.80 — V "L" Level VOL VIN OL = 50 μA 3.0 — 0 0.1 — 0.1		"H" Level	Vон					4.5	_		$\langle - \rangle$	
Voltage $^{\prime\prime}$ Level $^{\prime\prime}$ Voltage $^{\prime\prime}$ Level $^{\prime\prime}$ Voltage $^{\prime\prime}$ V				or V _{IL}		$\overline{}$		\rightarrow			7	
Voltage V_{OL} V_{IN} $V_$					$I_{OH} = -8mA$		(3.94 ≤) —	_	(3.80)	Š	V
	Voltage		I VOL	=VIH		-		0	0.1	70	/)0.1	
or V_{IL} $\begin{array}{ c c c c c c c c c c c c c c c c c c c$		"L" Level				3.0	/_	0	0.1	1-7	<u>√</u> /0.1	
Control Input Current I_{IN} $V_{IN} = 5.5V$ or GND $0 \sim 0 \sim 0.36$ — 0.44 $0 \sim 0 \sim 0 \sim 0.36$ — 0.44 $0 \sim 0 \sim 0 \sim 0.36$ — 0.44 $0 \sim 0 \sim 0 \sim 0.36$ — 0.44 $0 \sim 0 \sim 0 \sim 0.36$ — 0.44 $0 \sim 0.4$ — 0.44 — $0 \sim 0.4$ — 0.44 — $0 \sim 0.4$ — 0.44 — $0 \sim 0.4$ —						4.5	~	0			0.1	
Control Input Current I_{IN} $V_{IN} = 5.5V$ or GND $0 \sim 5.5$ $ \pm 0.1$ $ \pm 1.0$ μA Rx/Cx Terminal Off-State Current I_{IN} $V_{IN} = V_{CC}$ or GND 5.5 $ \pm 0.25$ $ \pm 0.25$ μA I_{CC} $V_{IN} = V_{CC}$ or GND 5.5 $ 2.0$ $ 20.0$					I _{OL} = 4mA		\nearrow	_	_	\mathcal{D}	0.44	
Control Input Current IIN VIN = 5.5V or GND 5.5 - ± 0.25 ± 1.0 μA Rx/Cx Terminal Off-State Current IIN VIN = VCC or GND 5.5 - ± 0.25 μA Quiescent Supply Current ICC VIN = VCC or GND 3.0 - ± 0.25 μA						IOL = 8mA	4.5	1	_	0.36	 	0.44
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Control Input Current		IN	V _{IN} = 5.	5V or GND	· ·			±0,1	_	± 1.0	μΑ
Quiescent Supply Current VIN = VCC or GND 4.5 — 380 500 — 650 µA	I		IN	V _{IN} = V	CC or GND	1	4	-))	± 0.25	_	± 0.25	μΑ
Current I_{CC} $V_{IN} = V_{CC}$ or GND 4.5 \rightarrow 380 500 \rightarrow 650 μ A	1 '''		Icc	VIN = VCC or GND		5.5	_	\searrow	2.0	_	20.0	μΑ
Current 100 By (6) = 0.50 = 0.50 = 0.50			VIN FVCC	V VE- AT CND		3.0	\wedge $-$	160	250	_	280	
5.5 560 750 — 975						/+	380	500	_	650		
				WX / ØX € 0.3 ACC		5.5	7	560	750		975	

TIMING RECOMMENDATION (Input $t_r = t_f = 3 \text{ ns}$)

CHARACTERISTIC	SYMBOL	TEST		Ta =	25°C	Ta = −40~85°C	UNIT	
CHARACTERISTIC	STANIBOL	CONDITION	ACC (A)	TYP.	LIMIT	LIMIT	ONIT	
Minimum Pulse Width	tw (L)		3.3 ± 0.3		5.0	5.0	ns	
Willimani Paise Widan	t _w (H)		5,0 ± 0.5	_	5.0	5.0	115	
Minimum Clear Width	D	\wedge	3.3 ± 0.3	_	5.0	5.0	ne	
(CLR)	^t w (L)		5.0 ± 0.5	_	5.0	5.0	ns	
		$Rx = 1k\Omega$	3.3 ± 0.3	60	-	_	ns	
Minimum Retrigger	△	Cx = 100pF	5.0 ± 0.5	39	_	_	113	
Time	trr /	$Rx = 1k\Omega$	3.3 ± 0.3	1.5	_	_	μs	
	7/	$Cx = 0.01 \mu F$	5.0 ± 0.5	1.2	-	_	,	

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DADAMETER	SYM-	TEST CONDITION		Ta = 25°C			Ta = −4	UNIT		
PARAMETER	BOL		V _{CC} (V)	CL (pF)	MIN.	TYP.	MAX.	MIN-	MAX.	UNIT
			3.3 ± 0.3	15	_	13.4	20.6	1.0	24.0	
Propagation Delay	^t pLH		3.3 ± 0.3	50	_	15.9	24.1	1.0	27.5	
Time (A, B-Q)			5.0 ± 0.5	15		⟨₹8.1 ⟨	(12.0)	1.0	14.0	
	^t pHL		3.0 ± 0.3	50	I	9.6	14.0	1.0	16.0	
Propagation Delay			3.3 ± 0.3	15	ı	14.5	22.4	1.0	26.0	
Time	t _{pLH}		3.5 2 0.5	50	1	17.0	25.9	1.0	29.5	
(CLR trigger-Q)	tpHL		5.0 ± 0.5	15	-6	8.7	12.9	1.0	15.0	ns
(CER digger-Q)	фпг		3.0 2 0.3	50	Z	10.2	14.9	1.0((17.0	113
	^t pLH tpHL	3.3 ± 0.3		15	-	10.3	15.8	1.0	18.5]
Propagation Delay			3.3 = 0.3	50	$\overline{2}$	12.8	19.3	1.0	22.0	
Time (CLR-Q)			5.0 ± 0.5	15	(//)	6.3	∕ 9.4	(1.0)	11.0	
			0.0 = 0.0	50		7.8	11.4	1.0	13.0	
		Cx = 28pF	3.3 ± 0.3		_	160	240	7-70	/300	
		$Rx = 2k\Omega$	5.0 ± 0.5		<u> </u>	133	200	$\overline{}$	240	
Output Pulse Width	twout		3.3 ± 0.3	50	> 90	100	110	90	110	μs
l .	WOOI	$Rx = 10k\Omega$	5.0 ± 0.5	12	90	100	110	90	110	μ3
		$Cx = 0.1 \mu F$	3.3 ± 0.3	50	0.9	1.0	<u>/ ⟨1∖1</u>	0.9	1.1	ms
		$Rx = 10k\Omega$	5.0 ± 0.5	3,0	0.9	1.0	1/1	0.9	1.1	1113
Input Capacitance	CIN		4/	\supset		4	10	_	10	pF
Power Dissipation Capacitance	C _{PD}	(A	lote 1)	4	1	73	-	_	_	ρi

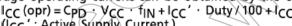
Note 1: CpD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

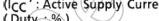
Average operating current can be obtained by the equation:

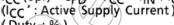
ICC (opr) = CpD · VCC · fIN + ICC ′ · Duty / 100 + ICC

(ICC ′ : Active Supply Current)

(Duty · %)



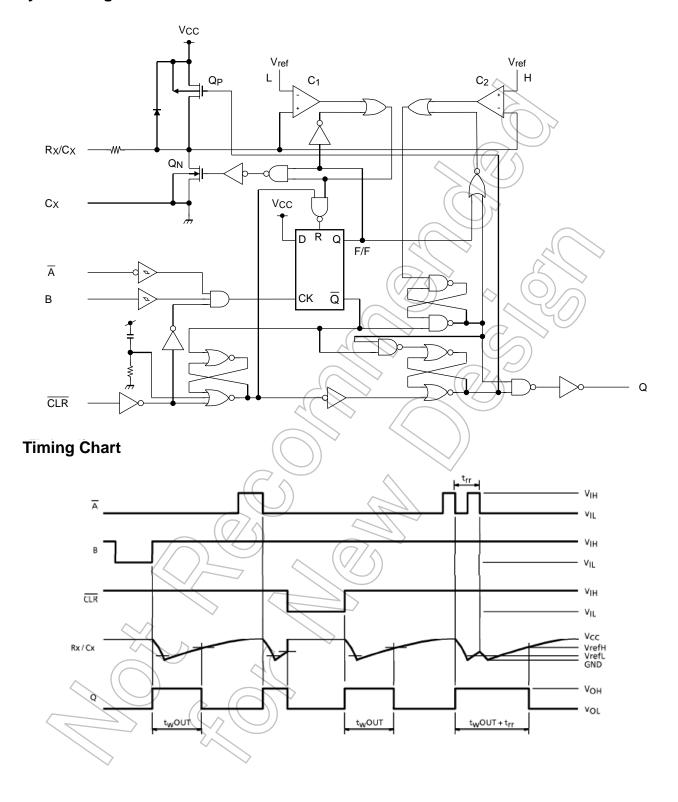






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System Diagram



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Package Dimensions

SSOP8-P-0.65 Unit: mm 4.0±0.1 2.8±0.1 1 0.650.650.65 2.9 ± 0.1 0.15±0.05 Weight: 0.02 g (Typ.)

Package Dimensions

SSOP8-P-0.50A Unit: mm 3.1±0.1 2.3±0.1 1 0.5 0.5 0.5 2.0 ± 0.1 0.12±0.04 Weight: 0.01 g (Typ.)

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